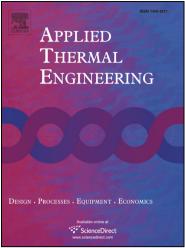
Accepted Manuscript

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PII: DOI:	\$1359-4311(17)31288-7 http://dx.doi.org/10.1016/j.applthermaleng.2017.07.183	D
Reference:	ATE 10851	
To appear in:	Applied Thermal Engineering	
Received Date:	25 February 2017	
Revised Date:	20 July 2017	
Accepted Date:	25 July 2017	



Please cite this article as: M. Yang, C. Li, Y. Zhang, Y. Wang, B. Li, D. Jia, Y. Hou, R. Li, Research on microscale skull grinding temperature field under different cooling conditions, *Applied Thermal Engineering* (2017), doi: http://dx.doi.org/10.1016/j.applthermaleng.2017.07.183

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Research on microscale skull grinding temperature field under different cooling conditions

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